

Wei Ye

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Education

University of Texas at Austin

Ph.D., Electrical and Computer Engineering, GPA: 3.87/4.00
Advisor: David Z. Pan

Austin, TX

Aug 2015 – May 2020

Zhejiang University

B.Eng., Electronic and Information Engineering, GPA: 3.96/4.00

Zhejiang, China

Sep 2011 – Jun 2015

Experience

Facebook

Research Scientist

- Facebook Reality Labs

Menlo Park, CA

Jun 2020 – Present

University of Texas at Austin

Graduate Research Assistant

- Machine learning and its applications in VLSI CAD
- Algorithm design for VLSI physical design automation

Austin, TX

Aug 2015 – May 2020

Kioxia (Toshiba Memory Corporation)

Research Intern

- Designed generative adversarial network (GAN) models for approximating time-consuming lithography simulation
- Achieved high accuracy on advanced benchmarks and 1000× speedup compared with conventional simulation tool

Yokohama, Japan

Jun 2019 – Aug 2019

Cadence Design Systems

Software Intern

- Designed and implemented socket communication and co-simulation framework between Cadence Voltus and Cadence Spectre

Austin, TX

May 2018 – Aug 2018

Synopsys Inc.

Technical Intern

- Designed and implemented algorithms for on-the-fly detection of design rule violations in clock tree synthesis
- Verified on commercial benchmarks and achieved improvement of slack estimation by 37% and final design quality

Sunnyvale, CA

May 2016 – Aug 2016

Publications

Book Chapter

[B1] **Wei Ye**, Mohamed Baker Alawieh, Che-Lun Hsu, Yibo Lin, and David Z. Pan, “Dealing with Aging and Yield in Scaled Technologies”, In: Dependable Embedded Systems. Springer, 2019

Journal Articles

[J1] Mohamed Baker Alawieh, Yibo Lin, **Wei Ye**, and David Z. Pan, “Generative Learning in VLSI Design for Manufacturability: Current Status and Future Directions”, Journal of Microelectronic Manufacturing (JOMM), 2019

Conference Papers

[C10] Mohamed Baker Alawieh, **Wei Ye**, and David Z. Pan, “Re-examining VLSI Manufacturing and Yield through the Lens of Deep Learning”, International Conference on Computer-Aided Design (ICCAD), 2020 (Invited, to appear)

[C9] **Wei Ye**, Mohamed Baker Alawieh, Yuki Watanabe, Nojima Shigeki, Yibo Lin, and David Z. Pan, “TEMPO: Fast Mask Topography Effect Modeling with Deep Learning”, ACM International Symposium on Physical Design (ISPD), 2020 (**Best Paper Award**)

- [C8] **Wei Ye**, Mohamed Baker Alawieh, Yibo Lin, and David Z. Pan, "LithoGAN: End-to-End Lithography Modeling with Generative Adversarial Networks", ACM/IEEE Design Automation Conference (DAC), 2019 (**Best Paper Finalist**)
- [C7] **Wei Ye**, Mohamed Baker Alawieh, Meng Li, Yibo Lin, and David Z. Pan, "Litho-GPA: Gaussian Process Assurance for Lithography Hotspot Detection", IEEE Design, Automation & Test in Europe Conference & Exhibition (DATE), 2019
- [C6] **Wei Ye**, Yibo Lin, Meng Li, Qiang Liu, and David Z. Pan, "LithoROC: Lithography Hotspot Detection with Explicit ROC Optimization", IEEE/ACM Asian and South Pacific Design Automation Conference (ASPDAC), 2019
- [C5] **Wei Ye**, Mohamed Baker Alawieh, Yibo Lin, and David Z. Pan, "Tackling Signal Electromigration with Learning-Based Detection and Multistage Mitigation", IEEE/ACM Asian and South Pacific Design Automation Conference (ASPDAC), 2019
- [C4] Yibo Lin, Mohamed Baker Alawieh, **Wei Ye**, and David Z. Pan, "Machine Learning for Yield Learning and Optimization", IEEE International Testing Conference (ITC), 2018 (Invited)
- [C3] **Wei Ye**, Meng Li, Kai Zhong, Bei Yu, and David Z. Pan, "Power Grid Reduction by Sparse Convex Optimization", ACM International Symposium on Physical Design (ISPD), 2018
- [C2] **Wei Ye**, Yibo Lin, Xiaoqing Xu, Wuxi Li, Yiwei Fu, Yongsheng Sun, Canhui Zhan, and David Z. Pan, "Placement Mitigation Techniques for Power Grid Electromigration", IEEE International Symposium on Low Power Electronics and Design (ISLPED), 2017
- [C1] **Wei Ye**, Bei Yu, Yong-Chan Ban, Lars Liebmann, and David Z. Pan, "Standard Cell Layout Regularity and Pin Access Optimization Considering Middle-of-Line", ACM Great Lakes Symposium on VLSI (GLSVLSI), 2015

Skills

Languages: C/C++, Python (Tensorflow, PyTorch), Verilog, MATLAB, Bash, \LaTeX

Tools: Boost C++ Libraries; Intel MKL library; Gurobi Solver; Hypergraph partitioning package (hMETIS)

Professional Service

Technical Program Committee (TPC) Member

- o IEEE International Conference on Computer Design (ICCD'20)

Reviewer/Second Reviewer

- o IEEE Transactions on Computer-Aided Design of Integrated Circuits and Systems (TCAD'15, 19, 20)
- o Integration, the VLSI Journal ('17)
- o ACM International Symposium on Physical Design (ISPD'17, 18, 20)
- o ACM/IEEE Design Automation Conference (DAC'19, 20)
- o IEEE/ACM International Conference on Computer-Aided Design (ICCAD'18)
- o ACM Great Lakes Symposium on VLSI (GLSVLSI'17, 18)

Selected Awards

2015–2019: UT Graduate Student Fellowship

University of Texas at Austin

2018: Cadence Women in Technology Scholarship

Cadence Design System

2012,2014: National Scholarship

Ministry of Education, P. R. China

2013: Samsung Scholarship

Zhejiang University